



MX554JBH32M7680

Ultra-Low Jitter 32.768MHz LVC MOS XO

ClockWorks® FUSION

General Description

The MX554JBH32M7680 is an ultra-low phase jitter XO with LVC MOS output optimized for high line rate applications.

Features

- 32.768MHz LVC MOS
- Typical phase noise:
 - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Absolute Maximum Ratings¹

Supply Voltage (VIN).....	+4.6V
Lead Temperature (soldering, 10s).....	260°C
Case Temperature.....	115°C
Storage Temperature (T _g).....	-65°C to +125°C
ESD Machine Model.....	.200V
ESD Rating (HBM).....	.2kV

Operating Ratings²

Supply Voltage (VIN).....	+2.375V to +3.63V
Ambient Temperature (TA).....	-40°C to +85°C
Junction Thermal Resistance	
LGA (T _{JA}) Still Air.....	58°C/W

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, output terminated with 50 Ohms to VDD/2.³

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			32.768		MHz
	Frequency Stability	Note 4			±50	ppm
∅j	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		131 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		500	ps
	Duty Cycle		45		55	%
VIH	Input High Voltage	3.3V Operation	2		VDD + 0.3	V
VIL	Input Low Voltage	3.3V Operation	-0.3		0.8	V
VOH	Output High Voltage	LVC MOS output levels	VDD - 0.8			V
VOL	Output Low Voltage	LVC MOS output levels			0.6	V

Notes:

1. Exceeding the absolute maximum ratings may damage the device.
2. The device is not guaranteed to function outside its operating ratings.
3. Guaranteed after thermal equilibrium.
4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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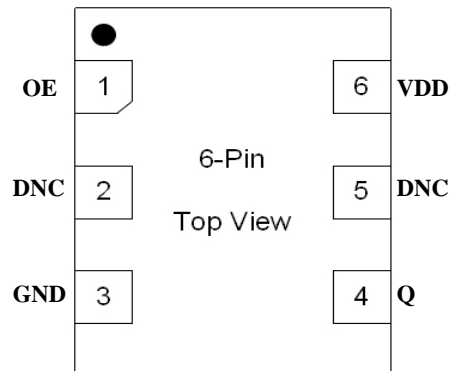
Revision 1.0
tcghelp@microchip.com

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554JBH32M7680	MX554J	BH0327	Tube	6-Pin 5mm x 3.2mm LGA
MX554JBH32M7680-TR	MX554J	BH0327	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVC MOS	Output Enable, disables output to tri-state, 1 = Disabled, 0 = Enabled, 50k Ohms Pull-Down (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, DNC	O, SE	LVC MOS	Clock Output Frequency = 32.768MHz
6	VDD	PWR		Power Supply

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition E
Mechanical Vibration	MIL-STD-883, Method 2007, Condition C
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10 ⁻⁸ atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

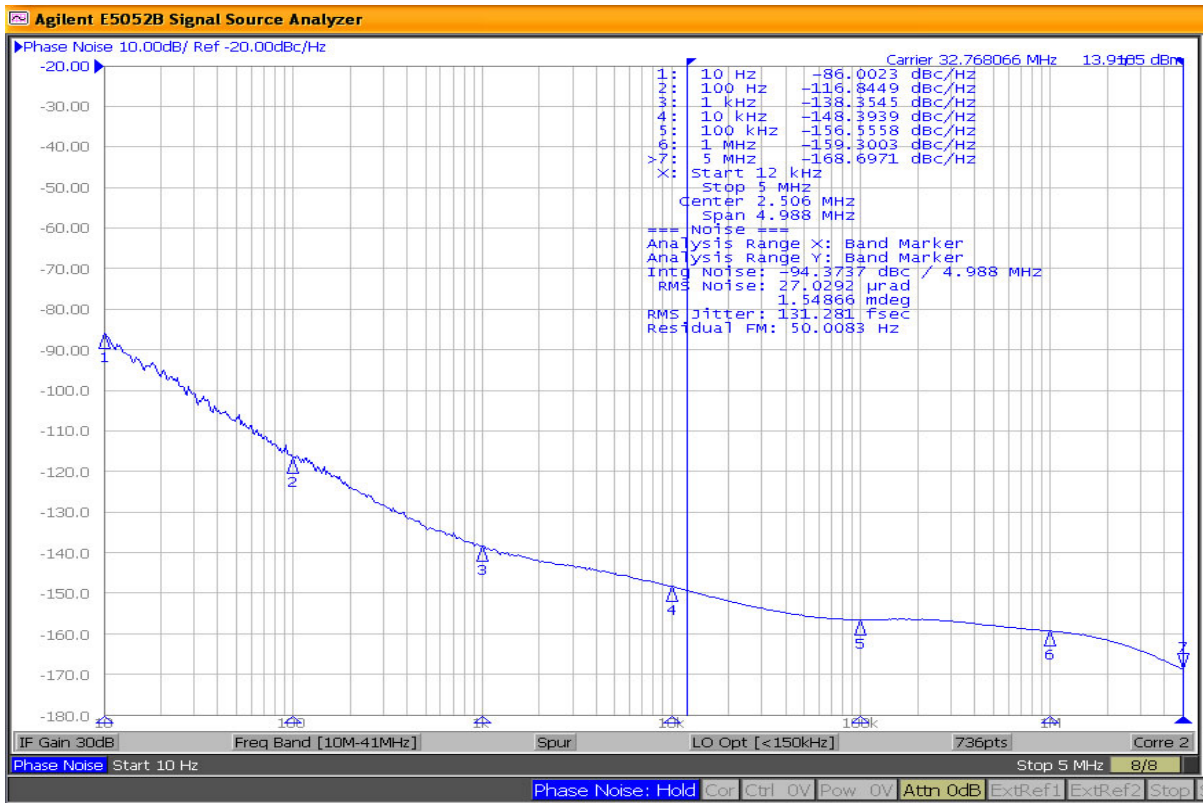
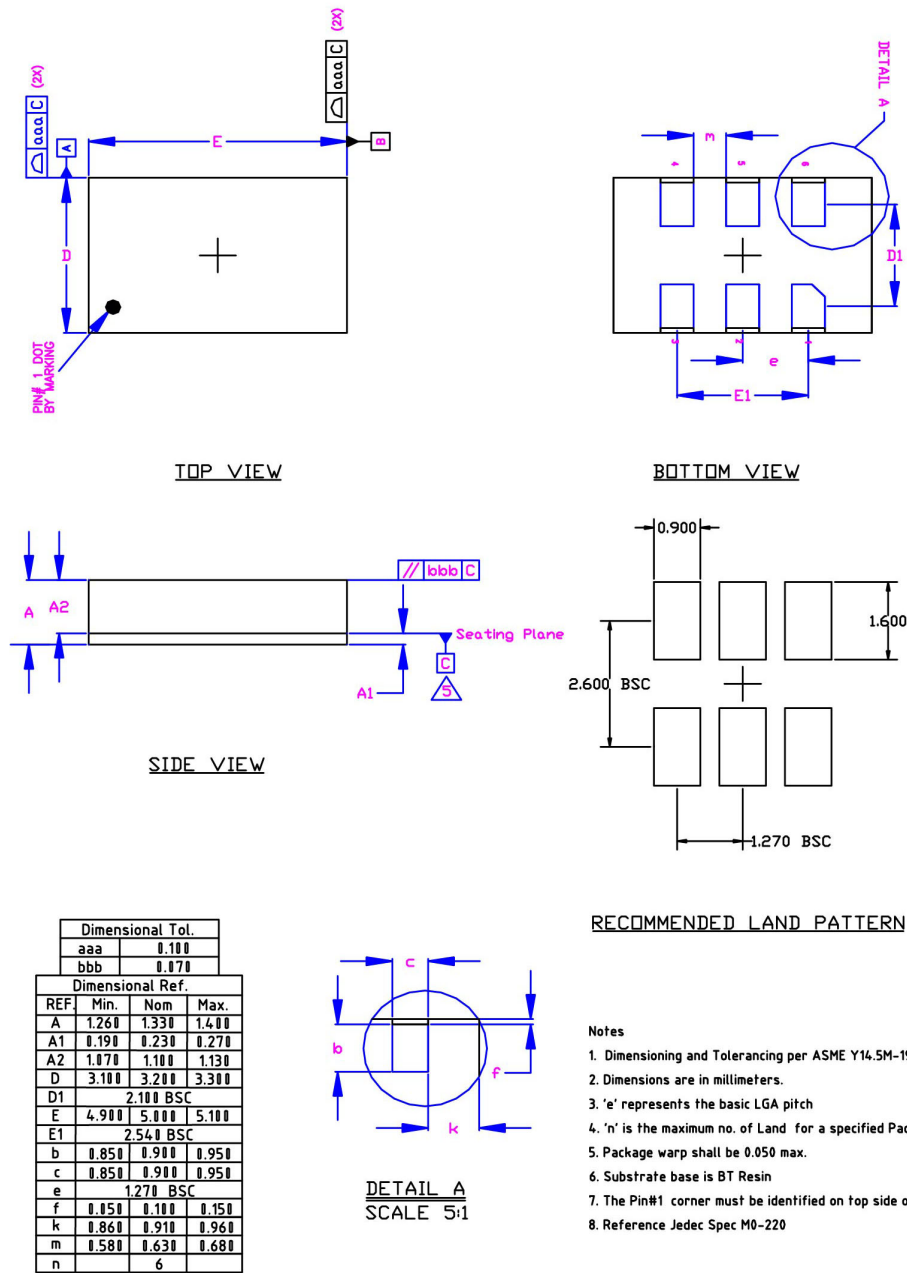


Figure 1. LVC MOS Output 32.768MHz 12kHz-5MHz 131fs

Package Information and Recommended Land Pattern for 6-Pin LGA³



RECOMMENDED LAND PATTERN

- Notes**
1. Dimensioning and Tolerancing per ASME Y14.5M-1994.
 2. Dimensions are in millimeters.
 3. 'e' represents the basic LGA pitch
 4. 'n' is the maximum no. of Land for a specified Package.
 5. Package warp shall be 0.050 max.
 6. Substrate base is BT Resin
 7. The Pin#1 corner must be identified on top side only.
 8. Reference Jeduc Spec M0-220

Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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